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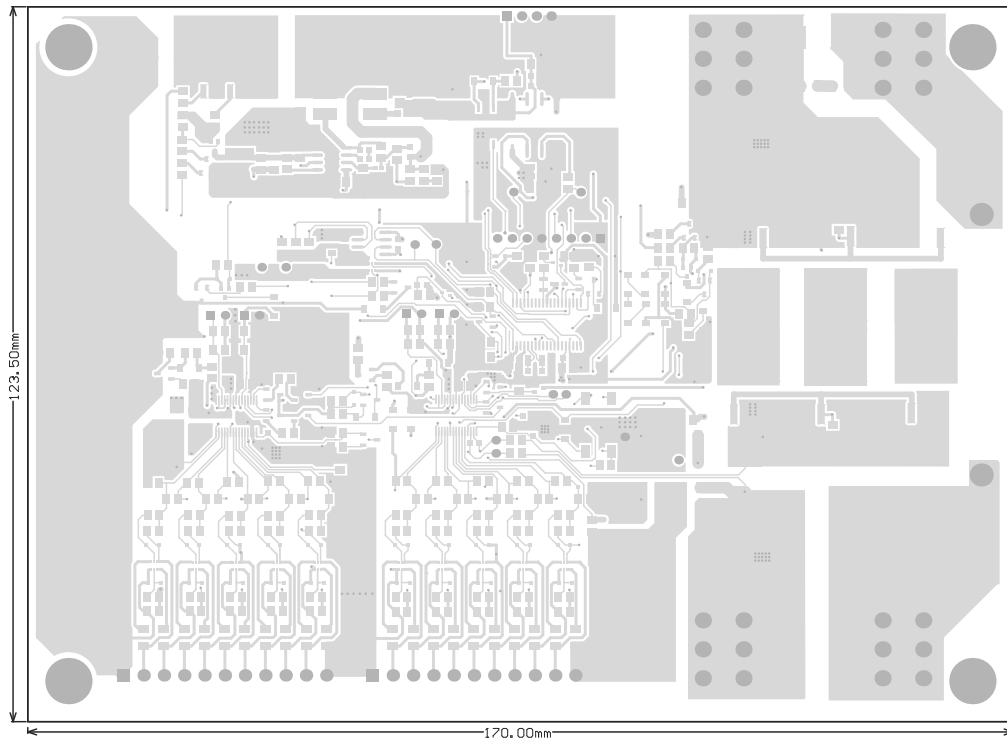
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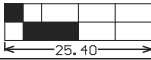
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123.50mm

170.00mm



DESIGN INFORMATION

MIN. TRACK WIDTH: 8 MIL
 MIN. CLEARANCE: 0.2 mm
 MIN. VIA PAD SIZE: 24 MIL
 MINIMUM ANNULAR RING 0.05mm (2MIL) EXTERNAL
 PER IPC-D-275 CLASS 2 LEVEL C
 REGISTRATION TOLERANCES: METAL +/- 5 MIL, HOLES +/- 3 MIL
 HOLE SIZE TOLERANCE (UNLESS OTHERWISE SPECIFIED): +/- 3 MIL

MATERIAL:
 FR-408 FR-4 High Tg OTHER
 THICKNESS: 62 MIL (1.6mm) +/-10% OTHER
 TOLERANCE: ANSI IPC-6012 TYPE 3 CLASS 2
 OTHER +/-
 BOW & TWIST: ANSI IPC-6012 TYPE 3 CLASS 2
 OTHER +/-

DRILLING:
 REFERENCE: AS SHOWN NC_DRILL FILES
 PTH MIN COPPER THICKNESS: 1MIL OTHER

BOARD FINISH:
 SILKSCREEN: TOP BOTTOM
 SILKSCREEN COLOR: WHITE OTHER
 SOLDER RESIST COLOR: GREEN OTHER
 MATTE SEMI-GLOSS

SURFACE FINISH: IMMERSION GOLD (ENIG) ENEPIG
 IMM. TIN/SILVER OR EQUIV OTHER

ARRAY/PANEL: CUT AND TRIM PER M1 BOARD OUTLINE
 N.C. ROUTE V. SCORE

CERTIFICATION: MATERIALS AND WORKMANSHIP FOR ALL PCBs TO MEET OR EXCEED THE REQUIREMENTS OF:
 ANSI IPC-A-600F CLASS -> 1 2 3
 RoHS OTHER PER ORDER

ALL BOARDS MUST MEET OR EXCEED UL94-V0 REQUIREMENTS.
 PCB MUST BEAR THE UL94V-0 UL REGISTERED MATERIAL ID NUMBER

ADDITIONAL REQUIREMENTS:
 MICROSECTION: YES
 BARE BOARD ELEC. TEST: NONE REQUIRED PER ORDER



PROJECT TITLE:
20S Battery Module Reference Design

DESIGNED FOR:
Public Release

FILE NAME:
20S_Reference_Design_TID_01093_E3.PcbDoc

ENGINEER: Steven Yao LAYOUT BY: Steven Yao

SCALE: 1.00 ALTUM DESIGNER VERSION: 14.3.14.34663

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01093	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: 01093		
PLOT NAME = Top Layer	GENERATED : 2016/7/11 16:10:36	TEXAS INSTRUMENTS	

Texas Instruments (TI) and/or its licensors do not warrant the accuracy or completeness of this specification or any information contained therein. TI and/or its licensors do not warrant that this design will meet the specifications, will be suitable for your application or fit for any particular purpose, or will operate in an implementation. TI and/or its licensors do not warrant that the design is production worthy. You should completely validate and test your design implementation to confirm the system functionality for your application.

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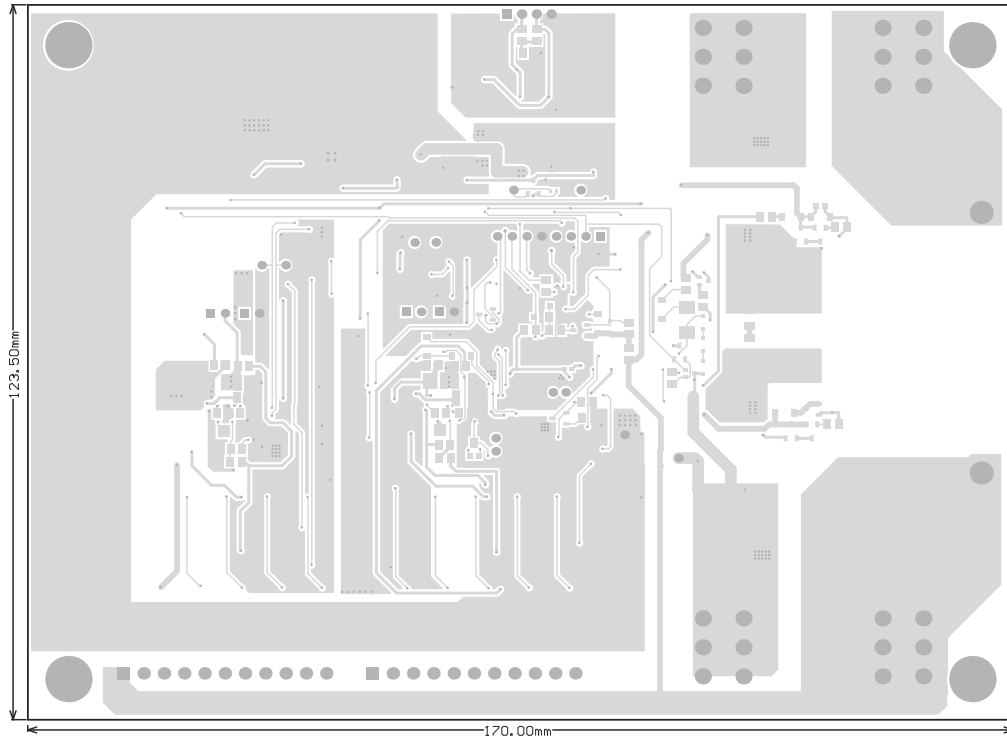
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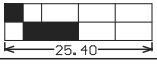
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123.50mm

170.00mm



DESIGN INFORMATION

MIN. TRACK WIDTH: 8 MIL
 MIN. CLEARANCE: 0.2 mm
 MIN. VIA PAD SIZE: 24 MIL
 MINIMUM ANNULAR RING 0.05mm (2MIL) EXTERNAL
 PER IPC-D-275 CLASS 2 LEVEL C
 REGISTRATION TOLERANCES: METAL +/- 5 MIL, HOLES +/- 3 MIL
 HOLE SIZE TOLERANCE (UNLESS OTHERWISE SPECIFIED): +/- 3 MIL

MATERIAL:
 FR-408 FR-4 High Tg OTHER _____
 THICKNESS: 62 MIL (1.6mm) +/-10% OTHER _____
 TOLERANCE: ANSI IPC-6012 TYPE 3 CLASS 2
 OTHER +/- _____
 BOW & TWIST: ANSI IPC-6012 TYPE 3 CLASS 2
 OTHER +/- _____

DRILLING:
 REFERENCE: AS SHOWN NC_DRILL FILES
 PTH MIN COPPER THICKNESS: 1MIL OTHER _____

BOARD FINISH:
 SILKSCREEN: TOP BOTTOM
 SILKSCREEN COLOR: WHITE OTHER _____
 SOLDER RESIST COLOR: GREEN OTHER _____
 MATTE SEMI-GLOSS

SURFACE FINISH: IMMERSION GOLD (ENIG) ENEPIG
 IMM. TIN/SILVER OR EQUIV OTHER _____

ARRAY/PANEL: CUT AND TRIM PER M1 BOARD OUTLINE
 N.C. ROUTE V. SCORE

CERTIFICATION: MATERIALS AND WORKMANSHIP FOR ALL PCBs TO MEET OR EXCEED THE REQUIREMENTS OF:
 ANSI IPC-A-600F CLASS -> 1 2 3
 RoHS OTHER PER ORDER

ALL BOARDS MUST MEET OR EXCEED UL94-V0 REQUIREMENTS. PCB MUST BEAR THE UL94V-0 UL REGISTERED MATERIAL ID NUMBER

ADDITIONAL REQUIREMENTS:
 MICROSECTION: YES
 BARE BOARD ELEC. TEST: NONE REQUIRED PER ORDER



PROJECT TITLE:
 20S Battery Module Reference Design

DESIGNED FOR:
 Public Release

FILE NAME:
 20S_Reference_Design_TID_01093_E3.PcbDoc

ENGINEER:
 Steven Yao

LAYOUT BY:
 Steven Yao

SCALE: 1.00

ALTIM DESIGNER VERSION:
 14.3.14.34663

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01093	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = 20S_Battery_Module Bottom Layer	TID #: 01093		
PLOT NAME = Bottom Layer	GENERATED : 2016/7/11 16:10:38	TEXAS INSTRUMENTS	

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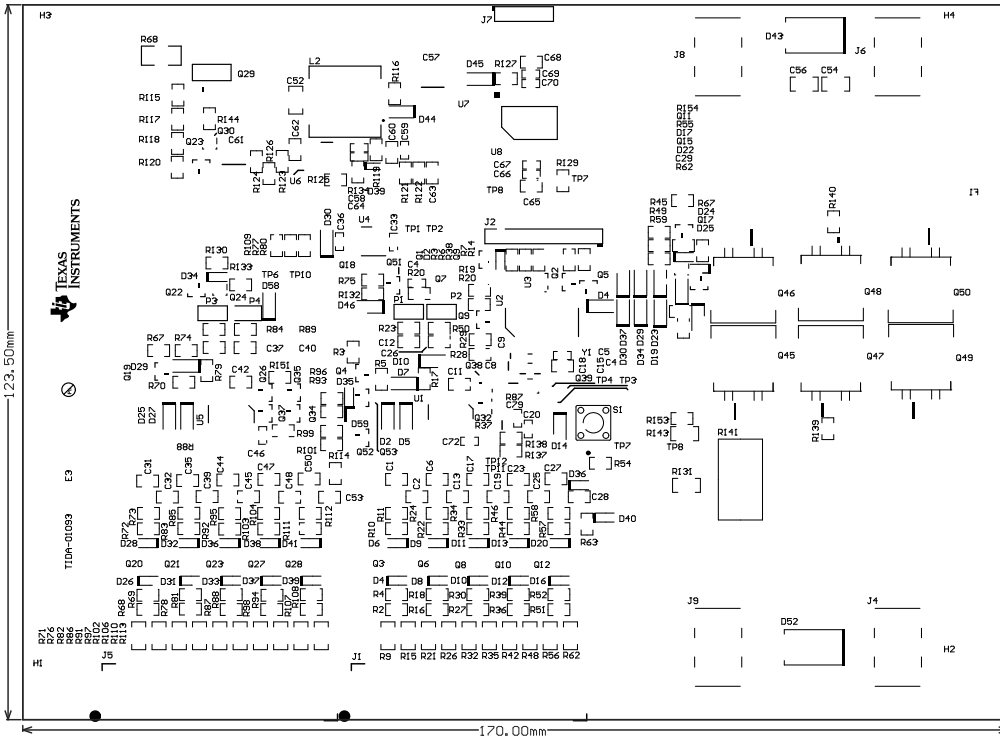
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DESIGN INFORMATION

MIN. TRACK WIDTH: 8 MIL
 MIN. CLEARANCE: 0.2 mm
 MIN. VIA PAD SIZE: 24 MIL
 MINIMUM ANNULAR RING 0.05mm (2MIL) EXTERNAL
 PER IPC-D-275 CLASS 2 LEVEL C
 REGISTRATION TOLERANCES: METAL +/- 5 MIL, HOLES +/- 3 MIL
 HOLE SIZE TOLERANCE (UNLESS OTHERWISE SPECIFIED): +/- 3 MIL

MATERIAL:
 FR-408 FR-4 High Tg OTHER
 THICKNESS: 62 MIL (1.6mm) +/-10% OTHER
 TOLERANCE: ANSI IPC-6012 TYPE 3 CLASS 2
 OTHER +/-
 BOW & TWIST: ANSI IPC-6012 TYPE 3 CLASS 2
 OTHER +/-

DRILLING:
 REFERENCE: AS SHOWN NC_DRILL FILES
 PTH MIN COPPER THICKNESS: 1MIL OTHER

BOARD FINISH:
 SILKSCREEN: TOP BOTTOM
 SILKSCREEN COLOR: WHITE OTHER
 SOLDER RESIST COLOR: GREEN OTHER
 MATTE SEMI-GLOSS

SURFACE FINISH: IMMERSION GOLD (ENG) ENEPIG
 IMM. TIN/SILVER OR EQUIV OTHER

ARRAY/PANEL: CUT AND TRIM PER M1 BOARD OUTLINE
 N.C. ROUTE V. SCORE

CERTIFICATION: MATERIALS AND WORKMANSHIP FOR ALL PCBs TO MEET OR EXCEED THE REQUIREMENTS OF:
 ANSI IPC-A-600F CLASS -> 1 2 3
 RoHS OTHER PER ORDER

ALL BOARDS MUST MEET OR EXCEED UL94-V0 REQUIREMENTS.
 PCB MUST BEAR THE UL94V-0 UL REGISTERED MATERIAL ID NUMBER

ADDITIONAL REQUIREMENTS:
 MICROSECTION: YES
 BARE BOARD ELEC. TEST: NONE REQUIRED PER ORDER



PROJECT TITLE:
20S Battery Module Reference Design

DESIGNED FOR:
Public Release

FILE NAME:
20S_Reference_Design_TID_01093_E3.PcbDoc

ENGINEER:
Steven Yao

LAYOUT BY:
Steven Yao

SCALE: 1.00

ALTUM DESIGNER VERSION:
14.3.14.34663

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01093	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Microcircuit Dimensions	TID #: 01093		
PLOT NAME = Top Silkscreen Overlay	GENERATED : 2016/7/11 16:10:41	TEXAS INSTRUMENTS	

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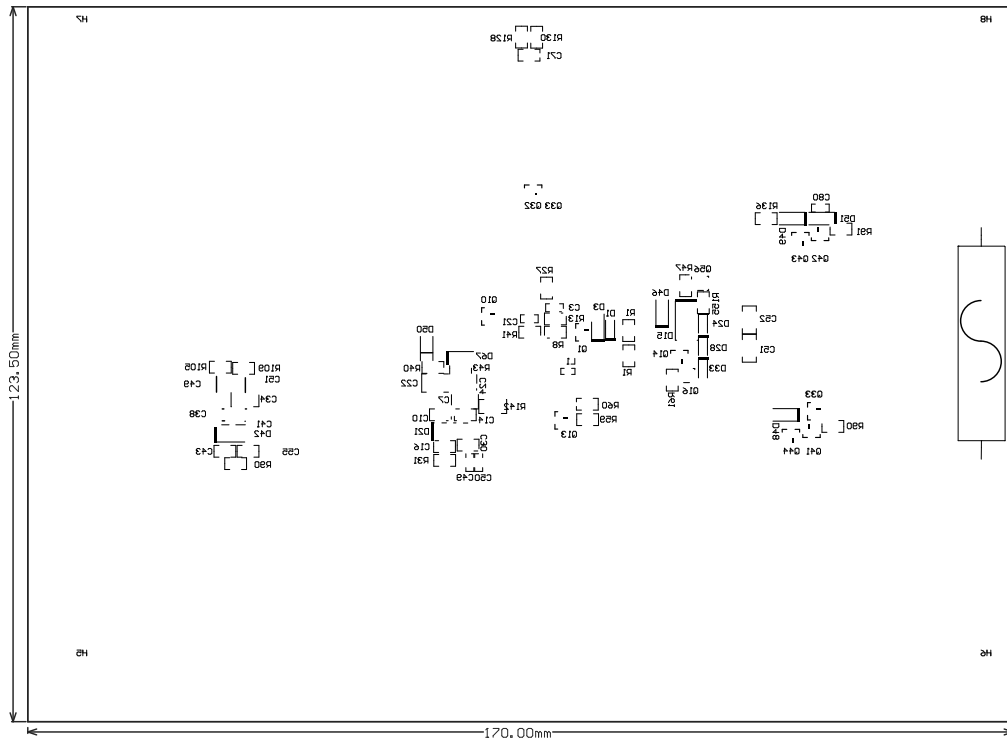
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DESIGN INFORMATION

MIN. TRACK WIDTH: 8 MIL
 MIN. CLEARANCE: 0.2 mm
 MIN. VIA PAD SIZE: 24 MIL
 MINIMUM ANNULAR RING 0.05mm (2MIL) EXTERNAL
 PER IPC-D-275 CLASS 2 LEVEL C
 REGISTRATION TOLERANCES: METAL +/- 5 MIL, HOLES +/- 3 MIL
 HOLE SIZE TOLERANCE (UNLESS OTHERWISE SPECIFIED): +/- 3 MIL

MATERIAL:
 FR-408 FR-4 High Tg OTHER
 THICKNESS: 62 MIL (1.6mm) +/-10% OTHER
 TOLERANCE: ANSI IPC-6012 TYPE 3 CLASS 2
 OTHER +/-
 BOW & TWIST: ANSI IPC-6012 TYPE 3 CLASS 2
 OTHER +/-

DRILLING:
 REFERENCE: AS SHOWN NC_DRILL FILES
 PTH MIN COPPER THICKNESS: 1MIL OTHER

BOARD FINISH:
 SILKSCREEN: TOP BOTTOM
 SILKSCREEN COLOR: WHITE OTHER
 SOLDER RESIST COLOR: GREEN OTHER
 MATTE SEMI-GLOSS

SURFACE FINISH: IMMERSION GOLD (ENG) ENEPIG
 IMM. TIN/SILVER OR EQUIV OTHER

ARRAY/PANEL: CUT AND TRIM PER M1 BOARD OUTLINE
 N.C. ROUTE V. SCORE

CERTIFICATION: MATERIALS AND WORKMANSHIP FOR ALL PCBs TO MEET OR EXCEED THE REQUIREMENTS OF:
 ANSI IPC-A-600F CLASS -> 1 2 3
 RoHS OTHER PER ORDER

ALL BOARDS MUST MEET OR EXCEED UL94-V0 REQUIREMENTS.
 PCB MUST BEAR THE UL94V-0 UL REGISTERED MATERIAL ID NUMBER

ADDITIONAL REQUIREMENTS:
 MICROSECTION: YES
 BARE BOARD ELEC. TEST: NONE REQUIRED PER ORDER



PROJECT TITLE:
20S Battery Module Reference Design

DESIGNED FOR:
Public Release

FILE NAME:
20S_Reference_Design_TID_01093_E3.PcbDoc

ENGINEER:
Steven Yao

LAYOUT BY:
Steven Yao

SCALE: 1.00

ALTIM DESIGNER VERSION:
14.3.14.34663

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01093	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Bottom Silkscreen Overlay	TID #: 01093		
PLOT NAME = Bottom Silkscreen Overlay	GENERATED : 2016/7/11 16:10:43	TEXAS INSTRUMENTS	

Texas Instruments (TI) and/or its licensors do not warrant the accuracy or completeness of this specification or any information contained therein. TI and/or its licensors do not warrant that this design will meet the specifications, will be suitable for your application or fit for any particular purpose, or will operate in an implementation. TI and/or its licensors do not warrant that the design is production worthy. You should completely validate and test your design implementation to confirm the system functionality for your application.

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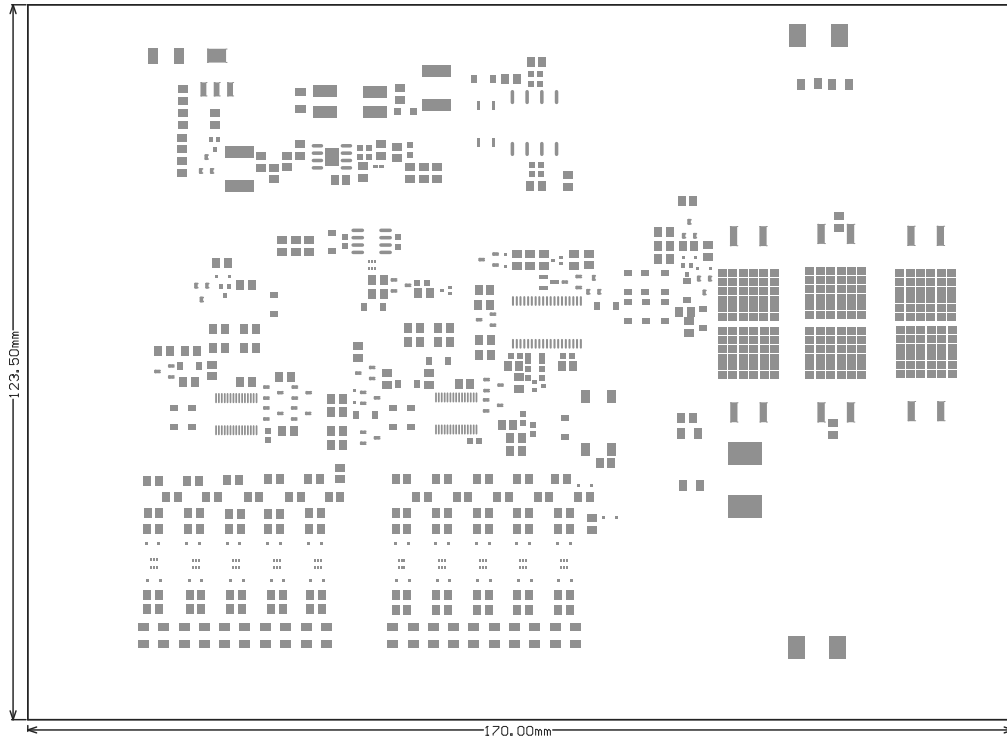
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DESIGN INFORMATION	
MIN. TRACK WIDTH:	8 MIL
MIN. CLEARANCE:	0.2 mm
MIN. VIA PAD SIZE:	24 MIL
MINIMUM ANNULAR RING 0.05mm (2MIL) EXTERNAL PER IPC-D-275 CLASS 2 LEVEL C	
REGISTRATION TOLERANCES: METAL +/- 5 MIL, HOLES +/- 3 MIL HOLE SIZE TOLERANCE (UNLESS OTHERWISE SPECIFIED): +/- 3 MIL	
MATERIAL:	
<input type="checkbox"/> FR-408 <input checked="" type="checkbox"/> FR-4 High Tg <input type="checkbox"/> OTHER _____	
THICKNESS:	<input checked="" type="checkbox"/> 62 MIL (1.6mm) +/-10% <input type="checkbox"/> OTHER _____
TOLERANCE:	<input checked="" type="checkbox"/> ANSI IPC-6012 TYPE 3 CLASS 2 <input type="checkbox"/> OTHER +/- _____
BOW & TWIST:	<input checked="" type="checkbox"/> ANSI IPC-6012 TYPE 3 CLASS 2 <input type="checkbox"/> OTHER +/- _____
DRILLING:	
REFERENCE:	<input checked="" type="checkbox"/> AS SHOWN <input checked="" type="checkbox"/> NC_DRILL FILES
PTH MIN COPPER THICKNESS:	<input checked="" type="checkbox"/> 1MIL <input type="checkbox"/> OTHER _____
BOARD FINISH:	
SILKSCREEN:	<input checked="" type="checkbox"/> TOP <input checked="" type="checkbox"/> BOTTOM
SILKSCREEN COLOR:	<input checked="" type="checkbox"/> WHITE <input type="checkbox"/> OTHER _____
SOLDER RESIST COLOR:	<input checked="" type="checkbox"/> GREEN <input type="checkbox"/> OTHER _____ <input checked="" type="checkbox"/> MATTE <input type="checkbox"/> SEMI-GLOSS
SURFACE FINISH:	<input checked="" type="checkbox"/> IMMERSION GOLD (ENIG) <input type="checkbox"/> ENEPIG <input type="checkbox"/> IMM. TIN/SILVER OR EQUIV <input type="checkbox"/> OTHER _____
ARRAY/PANEL:	<input type="checkbox"/> CUT AND TRIM PER M1 BOARD OUTLINE <input type="checkbox"/> N.C. ROUTE <input checked="" type="checkbox"/> V. SCORE
CERTIFICATION: MATERIALS AND WORKMANSHIP FOR ALL PCBs TO MEET OR EXCEED THE REQUIREMENTS OF:	
<input checked="" type="checkbox"/> ANSI IPC-A-600F CLASS -> <input type="checkbox"/> 1 <input checked="" type="checkbox"/> 2 <input type="checkbox"/> 3 <input checked="" type="checkbox"/> RoHS <input type="checkbox"/> OTHER PER ORDER	
ALL BOARDS MUST MEET OR EXCEED UL94-V0 REQUIREMENTS. PCB MUST BEAR THE UL94V-0 UL REGISTERED MATERIAL ID NUMBER	
ADDITIONAL REQUIREMENTS:	
MICROSECTION: <input type="checkbox"/> YES	
BARE BOARD ELEC. TEST: <input type="checkbox"/> NONE <input checked="" type="checkbox"/> REQUIRED <input type="checkbox"/> PER ORDER	



PROJECT TITLE: 20S Battery Module Reference Design	
DESIGNED FOR: Public Release	
FILE NAME: 20S_Reference_Design_TID_01093_E3.PcbDoc	
ENGINEER: Steven Yao	LAYOUT BY: Steven Yao
SCALE: 1.00	
ALTIM DESIGNER VERSION: 14.3.14.34663	

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01093	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = MPPasteMask	TID #: 01093		
PLOT NAME = Top Paste Mask Print	GENERATED : 2016/7/11 16:10:46	TEXAS INSTRUMENTS	

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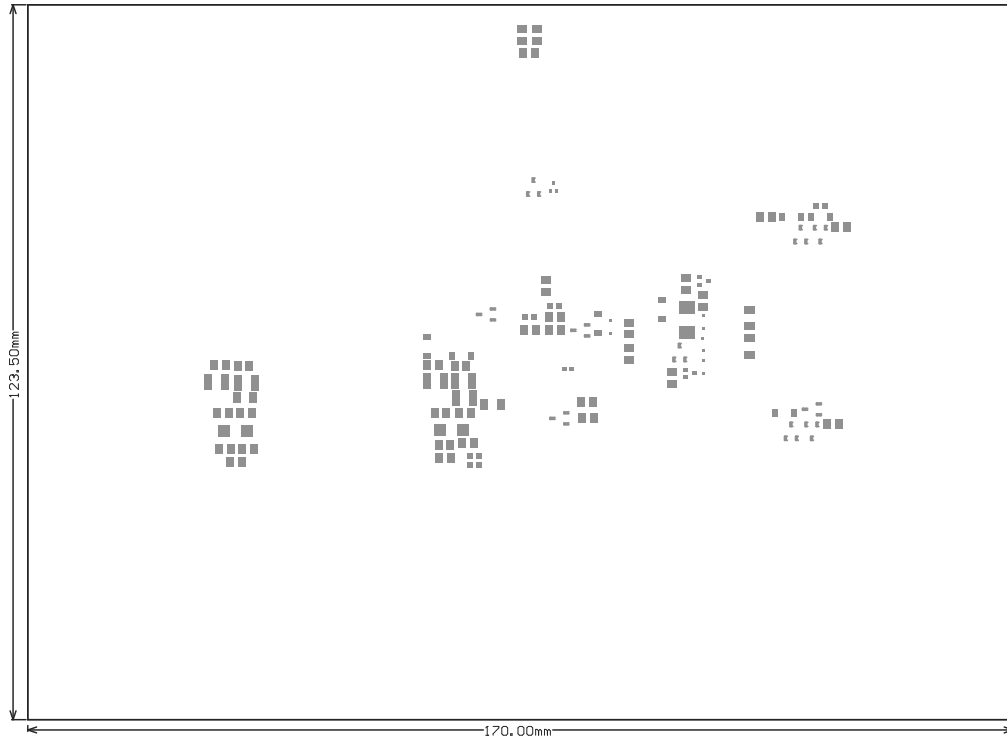
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DESIGN INFORMATION	
MIN. TRACK WIDTH:	8 MIL
MIN. CLEARANCE:	0.2 mm
MIN. VIA PAD SIZE:	24 MIL
MINIMUM ANNULAR RING 0.05mm (2MIL) EXTERNAL PER IPC-D-275 CLASS 2 LEVEL C	
REGISTRATION TOLERANCES: METAL +/- 5 MIL, HOLES +/- 3 MIL HOLE SIZE TOLERANCE (UNLESS OTHERWISE SPECIFIED): +/- 3 MIL	
MATERIAL:	
<input type="checkbox"/> FR-408 <input checked="" type="checkbox"/> FR-4 High Tg <input type="checkbox"/> OTHER	
THICKNESS:	<input checked="" type="checkbox"/> 62 MIL (1.6mm) +/-10% <input type="checkbox"/> OTHER
TOLERANCE:	<input checked="" type="checkbox"/> ANSI IPC-6012 TYPE 3 CLASS 2 <input type="checkbox"/> OTHER +/-
BOW & TWIST:	<input checked="" type="checkbox"/> ANSI IPC-6012 TYPE 3 CLASS 2 <input type="checkbox"/> OTHER +/-
DRILLING:	
REFERENCE:	<input checked="" type="checkbox"/> AS SHOWN <input checked="" type="checkbox"/> NC_DRILL FILES
PTH MIN COPPER THICKNESS:	<input checked="" type="checkbox"/> 1MIL <input type="checkbox"/> OTHER
BOARD FINISH:	
SILKSCREEN:	<input checked="" type="checkbox"/> TOP <input checked="" type="checkbox"/> BOTTOM
SILKSCREEN COLOR:	<input checked="" type="checkbox"/> WHITE <input type="checkbox"/> OTHER
SOLDER RESIST COLOR:	<input checked="" type="checkbox"/> GREEN <input type="checkbox"/> OTHER <input checked="" type="checkbox"/> MATTE <input type="checkbox"/> SEMI-GLOSS
SURFACE FINISH: <input checked="" type="checkbox"/> IMMERSION GOLD (ENIG) <input type="checkbox"/> ENEPIG <input type="checkbox"/> IMM. TIN/SILVER OR EQUIV <input type="checkbox"/> OTHER	
ARRAY/PANEL: <input type="checkbox"/> CUT AND TRIM PER M1 BOARD OUTLINE <input type="checkbox"/> N.C. ROUTE <input checked="" type="checkbox"/> V. SCORE	
CERTIFICATION: MATERIALS AND WORKMANSHIP FOR ALL PCBs TO MEET OR EXCEED THE REQUIREMENTS OF: <input checked="" type="checkbox"/> ANSI IPC-A-600F CLASS -> <input type="checkbox"/> 1 <input checked="" type="checkbox"/> 2 <input type="checkbox"/> 3 <input checked="" type="checkbox"/> RoHS <input type="checkbox"/> OTHER PER ORDER	
ALL BOARDS MUST MEET OR EXCEED UL94-V0 REQUIREMENTS. PCB MUST BEAR THE UL94V-0 UL REGISTERED MATERIAL ID NUMBER	
ADDITIONAL REQUIREMENTS: MICROSECTION: <input type="checkbox"/> YES	
BARE BOARD ELEC. TEST: <input type="checkbox"/> NONE <input checked="" type="checkbox"/> REQUIRED <input type="checkbox"/> PER ORDER	



PROJECT TITLE:
20S Battery Module Reference Design

DESIGNED FOR:
Public Release

FILE NAME:
20S_Reference_Design_TID_01093_E3.PcbDoc

ENGINEER:
Steven Yao

LAYOUT BY:
Steven Yao

SCALE: 1.00

ALTIM DESIGNER VERSION:
14.3.14.34663

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01093	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Top Paste Mask Print Bottom Paste Mask Print	TID #: 01093		
PLOT NAME = Bottom Paste Mask Print	GENERATED : 2016/7/11 16:10:48	TEXAS INSTRUMENTS	

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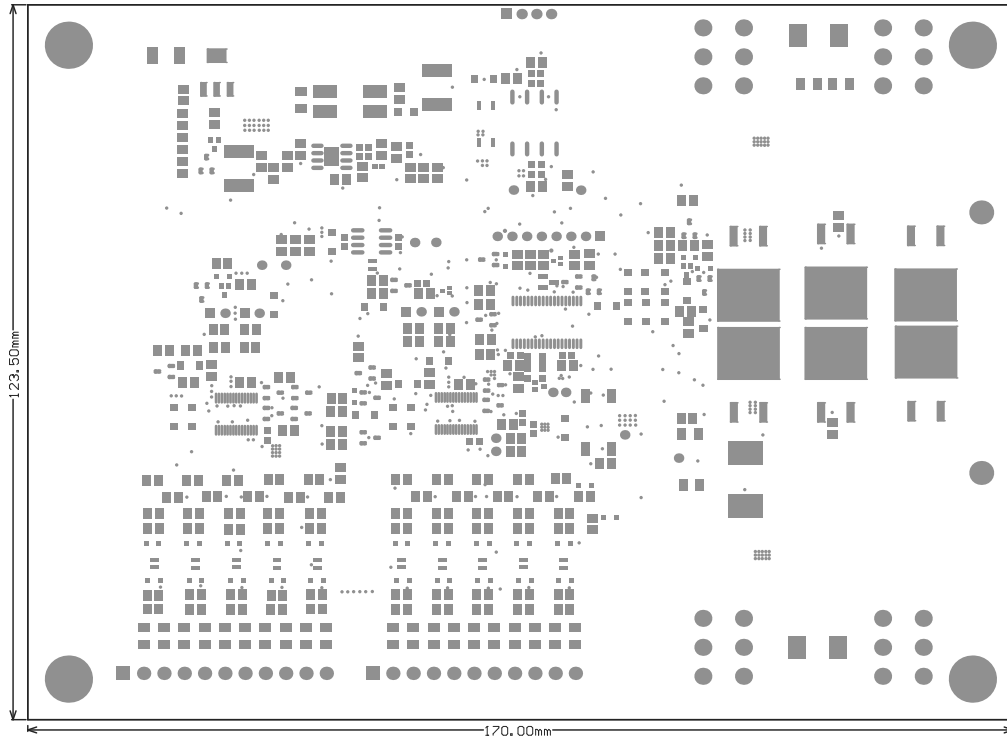
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DESIGN INFORMATION	
MIN. TRACK WIDTH:	8 MIL
MIN. CLEARANCE:	0.2 mm
MIN. VIA PAD SIZE:	24 MIL
MINIMUM ANNULAR RING 0.05mm (2MIL) EXTERNAL PER IPC-D-275 CLASS 2 LEVEL C	
REGISTRATION TOLERANCES: METAL +/- 5 MIL, HOLES +/- 3 MIL HOLE SIZE TOLERANCE (UNLESS OTHERWISE SPECIFIED): +/- 3 MIL	
MATERIAL:	
<input type="checkbox"/> FR-408 <input checked="" type="checkbox"/> FR-4 High Tg <input type="checkbox"/> OTHER	
THICKNESS:	<input checked="" type="checkbox"/> 62 MIL (1.6mm) +/-10% <input type="checkbox"/> OTHER
TOLERANCE:	<input checked="" type="checkbox"/> ANSI IPC-6012 TYPE 3 CLASS 2 <input type="checkbox"/> OTHER +/-
BOW & TWIST:	<input checked="" type="checkbox"/> ANSI IPC-6012 TYPE 3 CLASS 2 <input type="checkbox"/> OTHER +/-
DRILLING:	
REFERENCE:	<input checked="" type="checkbox"/> AS SHOWN <input checked="" type="checkbox"/> NC_DRILL FILES
PTH MIN COPPER THICKNESS:	<input checked="" type="checkbox"/> 1MIL <input type="checkbox"/> OTHER
BOARD FINISH:	
SILKSCREEN:	<input checked="" type="checkbox"/> TOP <input checked="" type="checkbox"/> BOTTOM
SILKSCREEN COLOR:	<input checked="" type="checkbox"/> WHITE <input type="checkbox"/> OTHER
SOLDER RESIST COLOR:	<input checked="" type="checkbox"/> GREEN <input type="checkbox"/> OTHER <input checked="" type="checkbox"/> MATTE <input type="checkbox"/> SEMI-GLOSS
SURFACE FINISH:	<input checked="" type="checkbox"/> IMMERSION GOLD (ENIG) <input type="checkbox"/> ENEPIG <input type="checkbox"/> IMM. TIN/SILVER OR EQUIV <input type="checkbox"/> OTHER
ARRAY/PANEL:	<input type="checkbox"/> CUT AND TRIM PER M1 BOARD OUTLINE <input type="checkbox"/> N.C. ROUTE <input checked="" type="checkbox"/> V. SCORE
CERTIFICATION: MATERIALS AND WORKMANSHIP FOR ALL PCBs TO MEET OR EXCEED THE REQUIREMENTS OF:	
<input checked="" type="checkbox"/> ANSI IPC-A-600F CLASS -> <input type="checkbox"/> 1 <input checked="" type="checkbox"/> 2 <input type="checkbox"/> 3 <input checked="" type="checkbox"/> RoHS <input type="checkbox"/> OTHER PER ORDER	
ALL BOARDS MUST MEET OR EXCEED UL94-V0 REQUIREMENTS. PCB MUST BEAR THE UL94V-0 UL REGISTERED MATERIAL ID NUMBER	
ADDITIONAL REQUIREMENTS:	
MICROSECTION: <input type="checkbox"/> YES	
BARE BOARD ELEC. TEST: <input type="checkbox"/> NONE <input checked="" type="checkbox"/> REQUIRED <input type="checkbox"/> PER ORDER	



PROJECT TITLE:
20S Battery Module Reference Design

DESIGNED FOR:
Public Release

FILE NAME:
20S_Reference_Design_TID_01093_E3.PcbDoc

ENGINEER:
Steven Yao

LAYOUT BY:
Steven Yao

SCALE: 1.00

ALTUM DESIGNER VERSION:
14.3.14.34663

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01093	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = MP Solder Mask Dimensions	TID #: 01093		
PLOT NAME = Top Solder Mask Print	GENERATED : 2016/7/11 16:10:50	TEXAS INSTRUMENTS	

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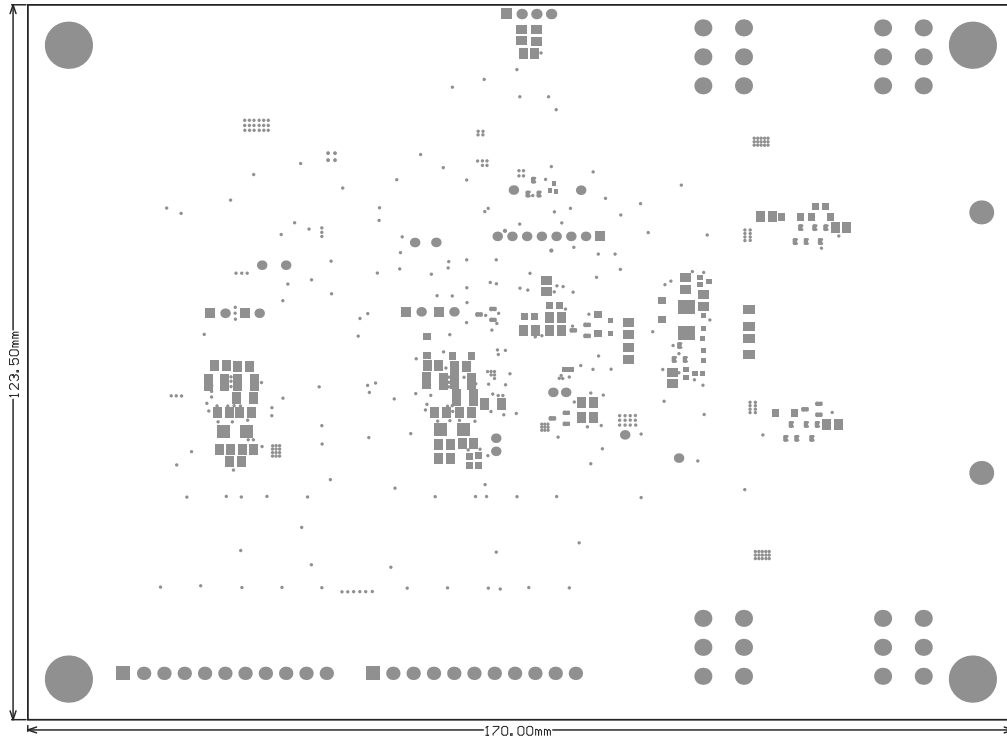
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DESIGN INFORMATION	
MIN. TRACK WIDTH:	8 MIL
MIN. CLEARANCE:	0.2 mm
MIN. VIA PAD SIZE:	24 MIL
MINIMUM ANNULAR RING 0.05mm (2MIL) EXTERNAL PER IPC-D-275 CLASS 2 LEVEL C	
REGISTRATION TOLERANCES: METAL +/- 5 MIL, HOLES +/- 3 MIL HOLE SIZE TOLERANCE (UNLESS OTHERWISE SPECIFIED): +/- 3 MIL	
MATERIAL:	
<input type="checkbox"/> FR-408 <input checked="" type="checkbox"/> FR-4 High Tg <input type="checkbox"/> OTHER _____	
THICKNESS:	<input checked="" type="checkbox"/> 62 MIL (1.6mm) +/-10% <input type="checkbox"/> OTHER _____
TOLERANCE:	<input checked="" type="checkbox"/> ANSI IPC-6012 TYPE 3 CLASS 2 <input type="checkbox"/> OTHER +/- _____
BOW & TWIST:	<input checked="" type="checkbox"/> ANSI IPC-6012 TYPE 3 CLASS 2 <input type="checkbox"/> OTHER +/- _____
DRILLING:	
REFERENCE:	<input checked="" type="checkbox"/> AS SHOWN <input checked="" type="checkbox"/> NC_DRILL FILES
PTH MIN COPPER THICKNESS:	<input checked="" type="checkbox"/> 1MIL <input type="checkbox"/> OTHER _____
BOARD FINISH:	
SILKSCREEN:	<input checked="" type="checkbox"/> TOP <input checked="" type="checkbox"/> BOTTOM
SILKSCREEN COLOR:	<input checked="" type="checkbox"/> WHITE <input type="checkbox"/> OTHER _____
SOLDER RESIST COLOR:	<input checked="" type="checkbox"/> GREEN <input type="checkbox"/> OTHER _____ <input checked="" type="checkbox"/> MATTE <input type="checkbox"/> SEMI-GLOSS
SURFACE FINISH: <input checked="" type="checkbox"/> IMMERSION GOLD (ENIG) <input type="checkbox"/> ENEPIG <input type="checkbox"/> IMM. TIN/SILVER OR EQUIV <input type="checkbox"/> OTHER _____	
ARRAY/PANEL: <input type="checkbox"/> CUT AND TRIM PER M1 BOARD OUTLINE <input type="checkbox"/> N.C. ROUTE <input checked="" type="checkbox"/> V. SCORE	
CERTIFICATION: MATERIALS AND WORKMANSHIP FOR ALL PCBs TO MEET OR EXCEED THE REQUIREMENTS OF: <input checked="" type="checkbox"/> ANSI IPC-A-600F CLASS -> <input type="checkbox"/> 1 <input checked="" type="checkbox"/> 2 <input type="checkbox"/> 3 <input checked="" type="checkbox"/> RoHS <input type="checkbox"/> OTHER PER ORDER	
ALL BOARDS MUST MEET OR EXCEED UL94-V0 REQUIREMENTS. PCB MUST BEAR THE UL94V-0 UL REGISTERED MATERIAL ID NUMBER	
ADDITIONAL REQUIREMENTS: MICROSECTION: <input type="checkbox"/> YES	
BARE BOARD ELEC. TEST: <input type="checkbox"/> NONE <input checked="" type="checkbox"/> REQUIRED <input type="checkbox"/> PER ORDER	



PROJECT TITLE:
20S Battery Module Reference Design

DESIGNED FOR:
Public Release

FILE NAME:
20S_Reference_Design_TID_01093_E3.PcbDoc

ENGINEER:
Steven Yao

LAYOUT BY:
Steven Yao

SCALE: 1.00

ALTIM DESIGNER VERSION:
14.3.14.34663

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01093	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder Mask	TID #: 01093		
PLOT NAME = Bottom Solder Mask Print	GENERATED : 2016/7/11 16:10:53	TEXAS INSTRUMENTS	

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1

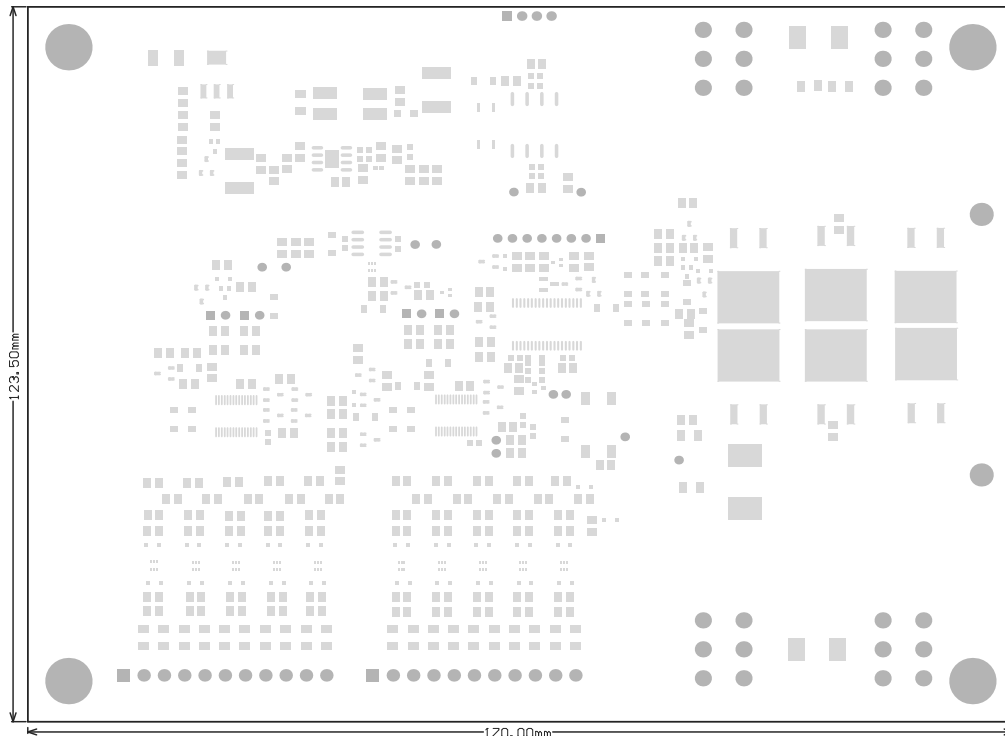
2

3

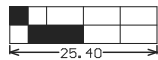
4

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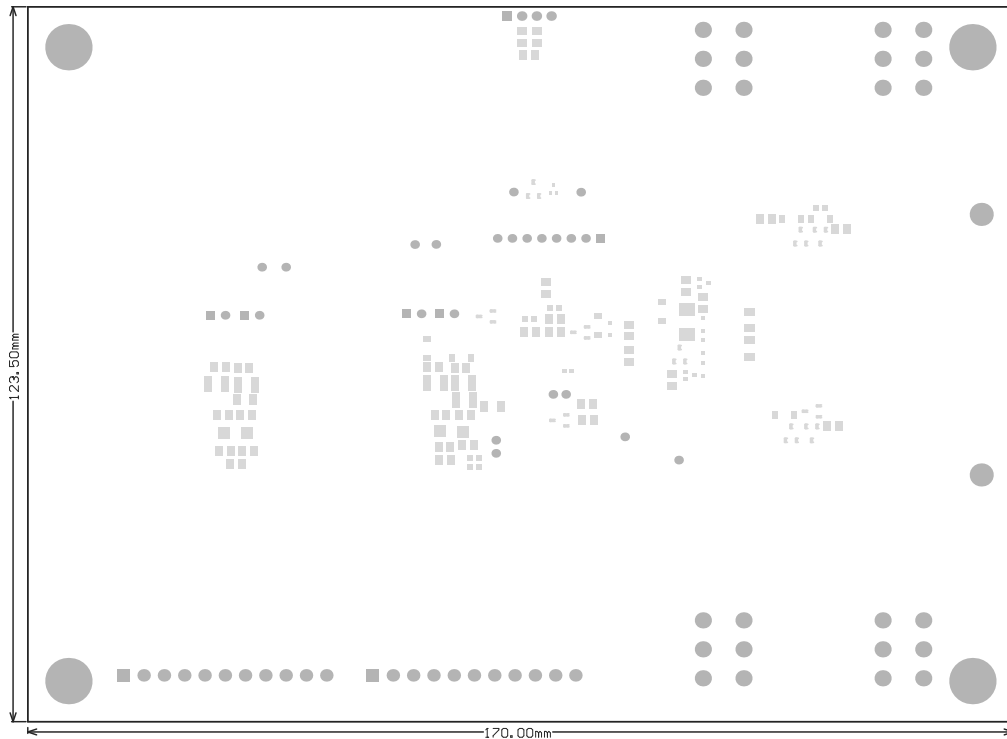
6



DESIGN INFORMATION	
MIN. TRACK WIDTH:	8 MIL
MIN. CLEARANCE:	0.2 mm
MIN. VIA PAD SIZE:	24 MIL
MINIMUM ANNULAR RING 0.05mm (2MIL) EXTERNAL PER IPC-D-275 CLASS 2 LEVEL C	
REGISTRATION TOLERANCES: METAL +/- 5 MIL, HOLES +/- 3 MIL	
HOLE SIZE TOLERANCE (UNLESS OTHERWISE SPECIFIED): +/- 3 MIL	
MATERIAL:	
<input type="checkbox"/> FR-408	<input checked="" type="checkbox"/> FR-4 High Tg <input type="checkbox"/> OTHER
THICKNESS:	<input checked="" type="checkbox"/> 62 MIL (1.6mm) +/-10% <input type="checkbox"/> OTHER
TOLERANCE:	<input checked="" type="checkbox"/> ANSI IPC-6012 TYPE 3 CLASS 2 <input type="checkbox"/> OTHER +/-
BOW & TWIST:	<input checked="" type="checkbox"/> ANSI IPC-6012 TYPE 3 CLASS 2 <input type="checkbox"/> OTHER +/-
DRILLING:	
REFERENCE:	<input checked="" type="checkbox"/> AS SHOWN <input checked="" type="checkbox"/> NC_DRILL FILES
PTH MIN COPPER THICKNESS:	<input checked="" type="checkbox"/> 1MIL <input type="checkbox"/> OTHER
BOARD FINISH:	
SILKSCREEN:	<input checked="" type="checkbox"/> TOP <input checked="" type="checkbox"/> BOTTOM
SILKSCREEN COLOR:	<input checked="" type="checkbox"/> WHITE <input type="checkbox"/> OTHER
SOLDER RESIST COLOR:	<input checked="" type="checkbox"/> GREEN <input type="checkbox"/> OTHER <input checked="" type="checkbox"/> MATTE <input type="checkbox"/> SEMI-GLOSS
SURFACE FINISH:	
<input checked="" type="checkbox"/> IMMERSION GOLD (ENIG)	<input type="checkbox"/> ENEPIG
<input type="checkbox"/> IMM. TIN/SILVER OR EQUIV	<input type="checkbox"/> OTHER
ARRAY/PANEL:	
<input type="checkbox"/> CUT AND TRIM PER M1 BOARD OUTLINE	<input checked="" type="checkbox"/> V. SCORE
<input type="checkbox"/> N.C. ROUTE	<input type="checkbox"/> V. SCORE
CERTIFICATION: MATERIALS AND WORKMANSHIP FOR ALL PCBs TO MEET OR EXCEED THE REQUIREMENTS OF:	
<input checked="" type="checkbox"/> ANSI IPC-A-600F CLASS ->	<input type="checkbox"/> 1 <input checked="" type="checkbox"/> 2 <input type="checkbox"/> 3
<input checked="" type="checkbox"/> RoHS	<input type="checkbox"/> OTHER PER ORDER
ALL BOARDS MUST MEET OR EXCEED UL94-V0 REQUIREMENTS. PCB MUST BEAR THE UL94V-0 UL REGISTERED MATERIAL ID NUMBER	
ADDITIONAL REQUIREMENTS:	
MICROSECTION:	<input type="checkbox"/> YES
BARE BOARD ELEC. TEST:	<input type="checkbox"/> NONE <input checked="" type="checkbox"/> REQUIRED <input type="checkbox"/> PER ORDER



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01093	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = M20 Board Dimensions	TID #: 01093		
PLOT NAME = Top Pad Master	GENERATED : 2016/7/11 16:10:55	TEXAS INSTRUMENTS	



DESIGN INFORMATION	
MIN. TRACK WIDTH:	8 MIL
MIN. CLEARANCE:	0.2 mm
MIN. VIA PAD SIZE:	24 MIL
MINIMUM ANNULAR RING 0.05mm (2MIL) EXTERNAL PER IPC-D-275 CLASS 2 LEVEL C	
REGISTRATION TOLERANCES: METAL +/- 5 MIL, HOLES +/- 3 MIL	
HOLE SIZE TOLERANCE (UNLESS OTHERWISE SPECIFIED): +/- 3 MIL	
MATERIAL:	
<input type="checkbox"/> FR-408 <input checked="" type="checkbox"/> FR-4 High Tg <input type="checkbox"/> OTHER _____	
THICKNESS:	<input checked="" type="checkbox"/> 62 MIL (1.6mm) +/-10% <input type="checkbox"/> OTHER _____
TOLERANCE:	<input checked="" type="checkbox"/> ANSI IPC-6012 TYPE 3 CLASS 2 <input type="checkbox"/> OTHER +/- _____
BOW & TWIST:	<input checked="" type="checkbox"/> ANSI IPC-6012 TYPE 3 CLASS 2 <input type="checkbox"/> OTHER +/- _____
DRILLING:	
REFERENCE:	<input checked="" type="checkbox"/> AS SHOWN <input checked="" type="checkbox"/> NC_DRILL FILES
PTH MIN COPPER THICKNESS:	<input checked="" type="checkbox"/> 1MIL <input type="checkbox"/> OTHER _____
BOARD FINISH:	
SILKSCREEN:	<input checked="" type="checkbox"/> TOP <input checked="" type="checkbox"/> BOTTOM
SILKSCREEN COLOR:	<input checked="" type="checkbox"/> WHITE <input type="checkbox"/> OTHER _____
SOLDER RESIST COLOR:	<input checked="" type="checkbox"/> GREEN <input type="checkbox"/> OTHER _____ <input checked="" type="checkbox"/> MATTE <input type="checkbox"/> SEMI-GLOSS
SURFACE FINISH: <input checked="" type="checkbox"/> IMMERSION GOLD (ENIG) <input type="checkbox"/> ENEPIG <input type="checkbox"/> IMM. TIN/SILVER OR EQUIV <input type="checkbox"/> OTHER _____	
ARRAY/PANEL: <input type="checkbox"/> CUT AND TRIM PER M1 BOARD OUTLINE <input type="checkbox"/> N.C. ROUTE <input checked="" type="checkbox"/> V. SCORE	
CERTIFICATION: MATERIALS AND WORKMANSHIP FOR ALL PCBs TO MEET OR EXCEED THE REQUIREMENTS OF: <input checked="" type="checkbox"/> ANSI IPC-A-600F CLASS -> <input type="checkbox"/> 1 <input checked="" type="checkbox"/> 2 <input type="checkbox"/> 3 <input checked="" type="checkbox"/> RoHS <input type="checkbox"/> OTHER PER ORDER	
ALL BOARDS MUST MEET OR EXCEED UL94-V0 REQUIREMENTS. PCB MUST BEAR THE UL94V-0 UL REGISTERED MATERIAL ID NUMBER	
ADDITIONAL REQUIREMENTS:	
MICROSECTION: <input type="checkbox"/> YES	
BARE BOARD ELEC. TEST: <input type="checkbox"/> NONE <input checked="" type="checkbox"/> REQUIRED <input type="checkbox"/> PER ORDER	

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01093	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = M20 Board Dimensions	TID #: 01093		
PLOT NAME = Bottom Pad Master	GENERATED : 2016/7/11 16:10:57	TEXAS INSTRUMENTS	

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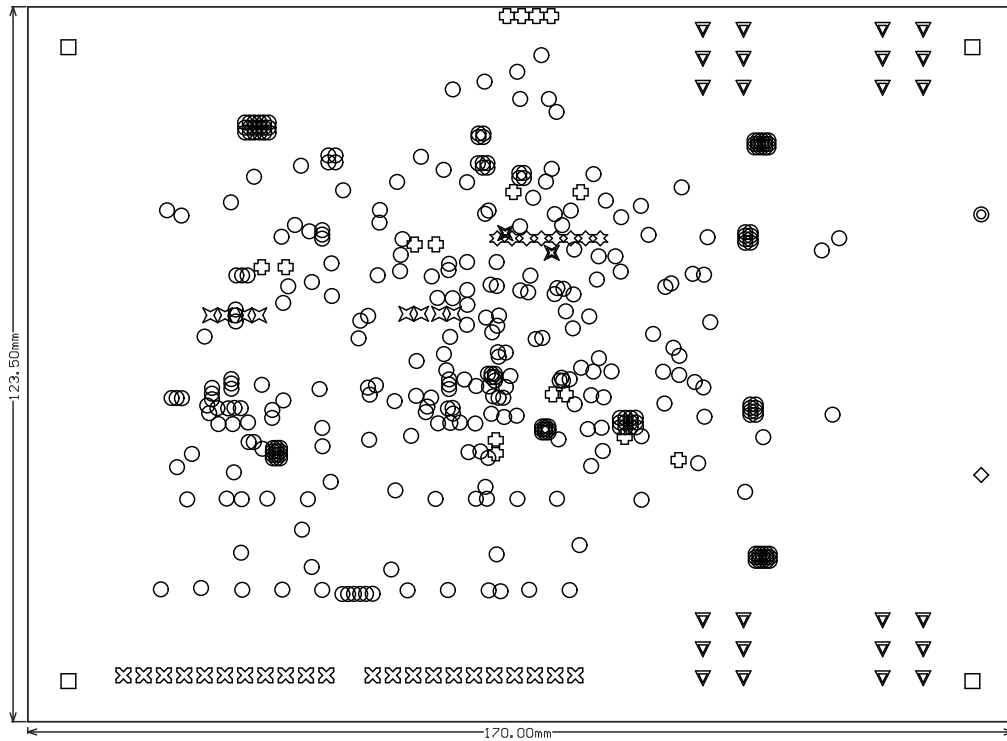
B

C

C

D

D



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
○	359	10.00mil (0.254mm)	PTH	Round
✕	2	12.00mil (0.305mm)	PTH	Round
✱	8	33.46mil (0.850mm)	PTH	Round
✱	8	35.43mil (0.900mm)	PTH	Round
⊙	16	33.27mil (1.000mm)	PTH	Round
⊗	22	52.00mil (1.321mm)	PTH	Round
◇	1	59.06mil (1.500mm)	PTH	Round
●	1	66.93mil (1.700mm)	PTH	Round
▽	24	76.00mil (1.930mm)	PTH	Round
□	4	125.58mil (3.200mm)	PTH	Round
	445 Total			

DESIGN INFORMATION

MIN. TRACK WIDTH: 8 MIL
 MIN. CLEARANCE: 0.2 mm
 MIN. VIA PAD SIZE: 24 MIL

MINIMUM ANNULAR RING 0.05mm (2MIL) EXTERNAL
 PER IPC-D-275 CLASS 2 LEVEL C
 REGISTRATION TOLERANCES: METAL +/- 5 MIL, HOLES +/- 3 MIL
 HOLE SIZE TOLERANCE (UNLESS OTHERWISE SPECIFIED): +/- 3 MIL

MATERIAL:
 FR-408 FR-4 High Tg OTHER _____

THICKNESS: 62 MIL (1.6mm) +/-10% OTHER _____

TOLERANCE: ANSI IPC-6012 TYPE 3 CLASS 2
 OTHER +/- _____

BOW & TWIST: ANSI IPC-6012 TYPE 3 CLASS 2
 OTHER +/- _____

DRILLING:
 REFERENCE: AS SHOWN NC_DRILL FILES
 PTH MIN COPPER THICKNESS: 1MIL OTHER _____

BOARD FINISH:
 SILKSCREEN: TOP BOTTOM
 SILKSCREEN COLOR: WHITE OTHER _____
 SOLDER RESIST COLOR: GREEN OTHER _____
 MATTE SEMI-GLOSS

SURFACE FINISH: IMMERSION GOLD (ENIG) ENEPIG
 IMM. TIN/SILVER OR EQUIV OTHER _____

ARRAY/PANEL: CUT AND TRIM PER M1 BOARD OUTLINE
 N.C. ROUTE V. SCORE

CERTIFICATION: MATERIALS AND WORKMANSHIP FOR ALL PCBs TO MEET OR EXCEED THE REQUIREMENTS OF:
 ANSI IPC-A-600F CLASS -> 1 2 3
 RoHS OTHER PER ORDER

ALL BOARDS MUST MEET OR EXCEED UL94-V0 REQUIREMENTS.
 PCB MUST BEAR THE UL94V-0 UL REGISTERED MATERIAL ID NUMBER

ADDITIONAL REQUIREMENTS:
 MICROSECTION: YES
 BARE BOARD ELEC. TEST: NONE REQUIRED PER ORDER



PROJECT TITLE:
20S Battery Module Reference Design

DESIGNED FOR:
Public Release

FILE NAME:
20S_Reference_Design_TID_01093_E3.PcbDoc

ENGINEER:
Steven Yao

LAYOUT BY:
Steven Yao

SCALE: 1.00

ALTUM DESIGNER VERSION:
14.3.14.34663

ALL ARTWORK VIEWED FROM TOP SIDE

LAYER NAME = **Drill Drawing**

PLOT NAME = Drill Drawing For <Bottom Layer>

BOARD #: TIDA-01093

TID #: 01093

REV: E3

SUN REV: Not In VersionControl

DATE: 2016/7/11 16:10:59

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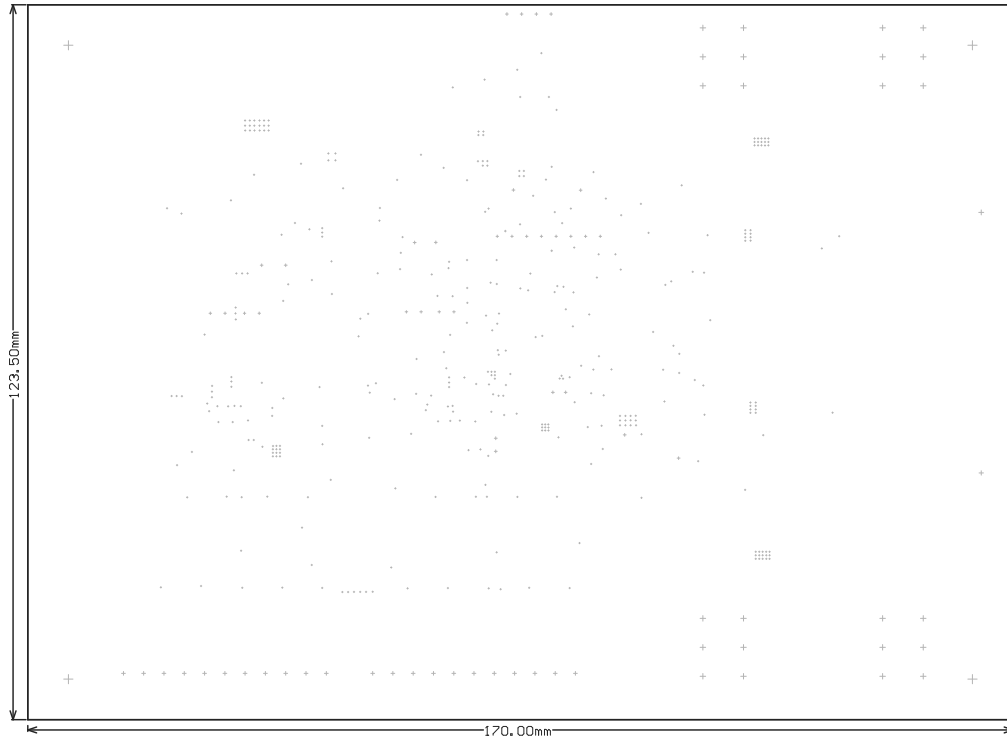
B

C

C

D

D



DESIGN INFORMATION	
MIN. TRACK WIDTH:	8 MIL
MIN. CLEARANCE:	0.2 mm
MIN. VIA PAD SIZE:	24 MIL
MINIMUM ANNULAR RING 0.05mm (2MIL) EXTERNAL PER IPC-D-275 CLASS 2 LEVEL C	
REGISTRATION TOLERANCES: METAL +/- 5 MIL, HOLES +/- 3 MIL HOLE SIZE TOLERANCE (UNLESS OTHERWISE SPECIFIED): +/- 3 MIL	
MATERIAL:	
<input type="checkbox"/> FR-408 <input checked="" type="checkbox"/> FR-4 High Tg <input type="checkbox"/> OTHER	
THICKNESS:	<input checked="" type="checkbox"/> 62 MIL (1.6mm) +/-10% <input type="checkbox"/> OTHER
TOLERANCE:	<input checked="" type="checkbox"/> ANSI IPC-6012 TYPE 3 CLASS 2 <input type="checkbox"/> OTHER +/-
BOW & TWIST:	<input checked="" type="checkbox"/> ANSI IPC-6012 TYPE 3 CLASS 2 <input type="checkbox"/> OTHER +/-
DRILLING:	
REFERENCE:	<input checked="" type="checkbox"/> AS SHOWN <input checked="" type="checkbox"/> NC_DRILL FILES
PTH MIN COPPER THICKNESS:	<input checked="" type="checkbox"/> 1MIL <input type="checkbox"/> OTHER
BOARD FINISH:	
SILKSCREEN:	<input checked="" type="checkbox"/> TOP <input checked="" type="checkbox"/> BOTTOM
SILKSCREEN COLOR:	<input checked="" type="checkbox"/> WHITE <input type="checkbox"/> OTHER
SOLDER RESIST COLOR:	<input checked="" type="checkbox"/> GREEN <input type="checkbox"/> OTHER <input checked="" type="checkbox"/> MATTE <input type="checkbox"/> SEMI-GLOSS
SURFACE FINISH:	<input checked="" type="checkbox"/> IMMERSION GOLD (ENIG) <input type="checkbox"/> ENEPIG <input type="checkbox"/> IMM. TIN/SILVER OR EQUIV <input type="checkbox"/> OTHER
ARRAY/PANEL:	<input type="checkbox"/> CUT AND TRIM PER M1 BOARD OUTLINE <input type="checkbox"/> N.C. ROUTE <input checked="" type="checkbox"/> V. SCORE
CERTIFICATION: MATERIALS AND WORKMANSHIP FOR ALL PCBs TO MEET OR EXCEED THE REQUIREMENTS OF:	
<input checked="" type="checkbox"/> ANSI IPC-A-600F CLASS -> <input type="checkbox"/> 1 <input checked="" type="checkbox"/> 2 <input type="checkbox"/> 3 <input checked="" type="checkbox"/> RoHS <input type="checkbox"/> OTHER PER ORDER	
ALL BOARDS MUST MEET OR EXCEED UL94-V0 REQUIREMENTS. PCB MUST BEAR THE UL94V-0 UL REGISTERED MATERIAL ID NUMBER	
ADDITIONAL REQUIREMENTS:	
MICROSECTION: <input type="checkbox"/> YES	
BARE BOARD ELEC. TEST: <input type="checkbox"/> NONE <input checked="" type="checkbox"/> REQUIRED <input type="checkbox"/> PER ORDER	



PROJECT TITLE:
20S Battery Module Reference Design

DESIGNED FOR:
Public Release

FILE NAME:
20S_Reference_Design_TID_01093_E3.PcbDoc

ENGINEER:
Steven Yao

LAYOUT BY:
Steven Yao

SCALE: 1.00

ALTIM DESIGNER VERSION:
14.3.14.34663

ALL ARTWORK VIEWED FROM TOP SIDE

BOARD #: TIDA-01093

REV: E3

SUN REV: Not In VersionControl

LAYER NAME = ~~Bottom Layer~~

TID #: 01093

PLOT NAME = Drill Guide For (Bottom Layer)

DATE : 2016/7/11 16:11:02

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